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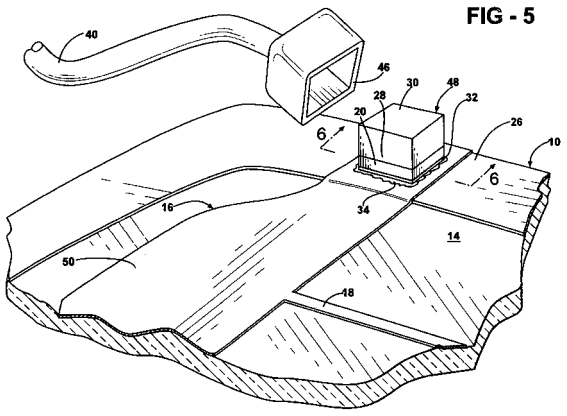
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(54) **An electrical connector for a window pane of a vehicle**

(57) A window pane (10) has a substrate (14) formed from glass and includes an electrical device (24). The electrical device includes an electrical conductor (16) and an electrical connector (20). A layer (32) of solderable metal is bonded to the connector. A layer of solder is bonded to the layer of solderable metal and the conductor, with the connector and the conductor in electrical communication through the layer of solderable metal and the layer of solder. The substrate has a first coefficient of expansion and the connector has a second coefficient of thermal expansion. A difference between the first and second coefficients of thermal expansion is equal to or less than 5 x 10^{-6} /°C for minimizing mechanical stress between the connector and the substrate due to thermal expansion of the connector and the substrate resulting from changes in temperature. The solder is comprised of less than 70 parts by weight of Sn along with a greater than 30 parts by weight of a reaction rate modifier. The reaction rate modifier increases the solderability of the solder to the conductor.

FIG - 5



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EUROPEAN SEARCH REPORT

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EP 08 25 0009

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The present search report has been drawn up for all claims

Place of search	Date of completion of the search	Examiner
Munich	4 February 2009	Gea Haupt, Martin

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